

DPDT Non-Latching Surface Mount 2.5GHz RF Relay

GRF172 -5

SURFACE MOUNT CENTIGRID® 2.5 GHz RF RELAYS DPDT



SERIES	RELAY TYPE		
GRF172	DPDT Surface mount, RF Centigrid [®] relay		
GRF172D	DPDT Surface mount, RF Centigrid® relay with coil transient suppression		

DESCRIPTION

The GRF172 surface-mount Centigrid® relay is an ultraminiature, hermetically sealed, armature relay for 2.5 GHz RF applications. Its low profile height (.330") and .100" grid spaced terminals make it an ideal choice where extreme packaging density and/or close PC board spacing are required.

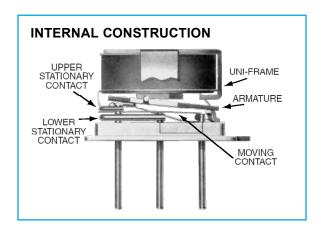
The GRF172 features a unique ground shield that isolates and shields each lead to ensure excellent contact-to-contact and pole-to-pole isolation. This ground shield provides a ground interface that results in improved highfrequency performance as well as parametric repeatability. The GRF172 extends performance advantages over similar RF devices that simply offer formed leads for surface mounting.

- Unique construction features and manufacturing techniques provide overall high reliability and excellent resistance to environmental extremes:
- All welded construction.
- Unique uni-frame design providing high magnetic efficiency and mechanical rigidity.
- High force/mass ratios for resistance to shock and vibration.
- Advanced cleaning techniques provide maximum assurance of internal cleanliness.
- Precious metal alloy contact material with gold plating assures excellent high current and dry circuit switching capabilities.

Applications include telecommunications, test instruments, mobile communications, attenuators, and automatic test equipment.

PHYSICAL SPECIFICATIONS						
Temperature (Ambient)	–65°C to +125°C					
Vibration (General Note I)	10 g's to 500 Hz					
Shock (General Note I)	30 g's, 6ms half sine					
Enclosure	Hermetically sealed					
Weight	0.15 oz. (4.3g) max.					

ENVIRONMENTAL AND



DPDT Non-Latching Surface Mount 2.5GHz RF Relay

TELEDYNE RELAYS Everywhereyoulook"

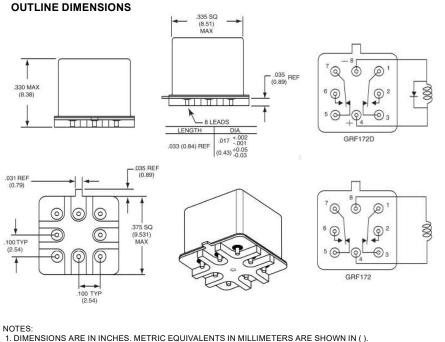
SERIES GRF172

GENERAL ELECTRICAL SPECIFICATIONS (@25°C Notes 2 & 5)						
Contact Arrangement	2 Form C (DPDT)					
Rated Duty	Continuous					
Contact Resistance	0.15Ω max. Before life; 0.3 ohm max. After life at 1A/28Vdc (measured 1/8" from header					
Contact Load Rating	Resistive: 1 A/ 28 Vdc Inductive: 200 mA/ 28 Vdc (320mH) Lamp: 100 mA / 28 Vdc Low level: 10 to 50 μA @ 10 to 50 mV					
Contact Life Ratings	5,000,000 cycles (typical) at low level 500,000 cycles (typical) at 0.5 A / 28 Vdc resistive 100,000 cycles min. at all other loads specified above					
Contact Overload Rating	2 A / 28 Vdc Resistive (100 cycles min.)					
Contact Carry Rating	Contact Factory					
Operate Time	6.0 msec max. at nominal rated coil voltage					
Release Time	GRF172: 3.0 ms max.	GRF172D: 6.0 ms max.				
Intercontact Capacitance	0.4 pf typical					
Insulation Resistance	1,000 M Ω min. between mutually isolated terminals					
Dielectric Strength	300 Vrms (60 Hz) @ atmospheric pressure					
Negative Coil Transient (Vdc)	2.0 Vdc Max.					
Diode P.I.V. (Vdc)	60 Vdc Min.					

DETAILED ELECTRICAL SPECIFICATIONS (@25°C)

BASE PART NUMBERS (GRF172, GRF172D)		GRF172-5 GRF172D-5	GRF172-12 GRF172D-12	GRF172-26 GRF172D-26
Coil Voltage, Nominal (Vdc)	Nom.	5.0	12.0	26.5
con vonage, Nomman (Vuc)	Max.	5.8	16.0	32.0
Coil Resistance (Ohms ±25%)	64	400	1600	
Pick-up Voltage (Vdc, Max.) Pulse Operation	3.8	9.0	18.0	
Coil Operating Power at Nominal Voltage (mW	405	360	440	

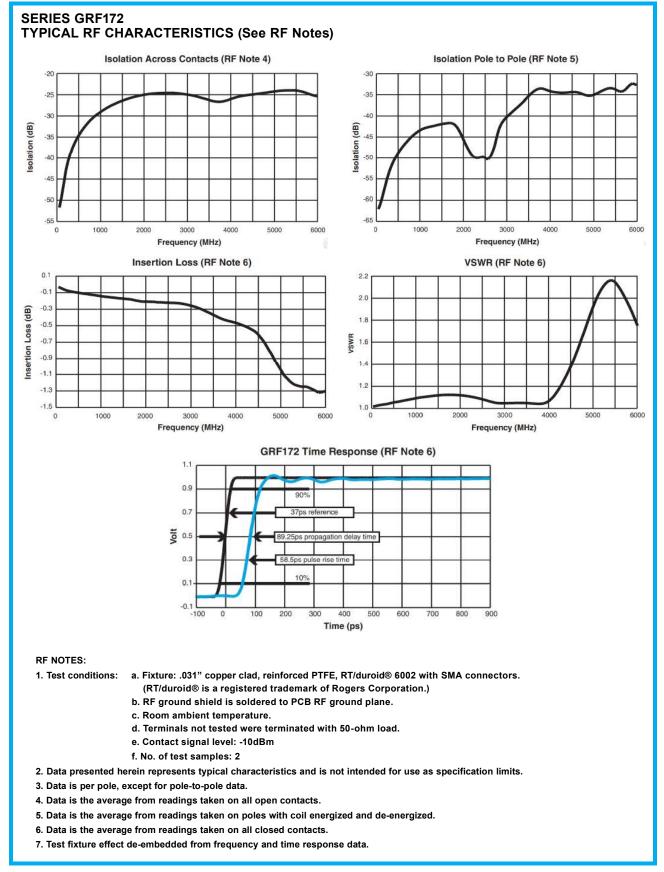
- GENERAL NOTES 1. Relays will exhibit no contact chatter in excess of 10 µsec or transfer in excess
- of 1 µsec. 2. Unless otherwise specified, parameters
- are initial values.
 Relays may be subjected to 260°C, peak solder reflow temperature, 1
- minute, 3 passes. 4. Butt-lead ends are coplanar within .003" (0.08).
- "Typical" characteristics are based on available data and are best estimates. No on-going verification tests are
- performed. Application notes available for PCB 6. layout and mounting information.



2. UNLESS OTHERWISE SPECIFIED, TOLERANCES ON DIMENSIONS ARE ±.010 INCH (0.025 mm). 3. FOR OPTIMAL RF PERFORMANCE, SOLDER BOTTOM OF GROUND SHIELD TO PCB RF GROUND PLANE.



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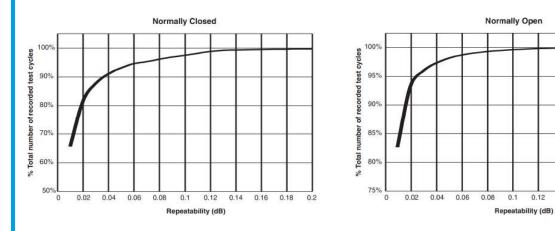
> 0.12 0.14

0.16 0.18

0.2



SERIES GRF172 TYPICAL RF INSERTION LOSS REPEATABILITY CHARACTERISTICS (See RF Insertion Loss Repeatability Notes)



RF INSERTION LOSS REPEATABILITY NOTES:

1. Test conditions: a. Fixture: .031" copper clad, reinforced PTFE, RT/duroid® 6002 with SMA connectors.

- (RT/duroid® is a registered trademark of Rogers Corporation.)
 - b. Test performed at room abient temperature
- c. Contact signal level: -10dBm
- 2. Data presented herein represents typical characteristics and is not intended for use as specification limits.
- 3. Insertion loss repeatability measured over frequency range from 50 MHz to 4 GHz

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